

AMENDMENTS TO THE CLAIMS:

Please amend Claims 22, 28 and 29 as follows. Note all the claims currently pending in this application, including those not presently amended, have been reproduced below for the Examiner's convenience.

1-21. (Cancelled)

22. (Currently Amended) A pod ~~attachable to an outside surface of an~~ for attachment to a grounded electromagnetic-shielded chamber ~~which covers~~ containing a device manufacturing apparatus, ~~the device manufacturing apparatus importing a substrate from said pod~~ for processing a substrate, said pod comprising:

walls for containing a substrate; and

a lid for an opening defined by the walls, ~~the substrate in said pod being imported to the device manufacturing apparatus through the opening,~~ for transferring the substrate between said pod and the grounded electromagnetic-shielded chamber,

wherein said walls comprise an electromagnetic shield member, ~~and a portion of said electromagnetic shield member is arranged on a part of said walls which contacts the~~ including a portion to contact the grounded electromagnetic-shielded chamber during the attachment of said pod to the grounded electromagnetic-shielded chamber.

23. (Previously Presented) A pod according to Claim 22, wherein said lid is arranged in front of said pod.

24. (Previously Presented) A pod according to Claim 22, wherein said lid is arranged in a bottom of said pod.

25. (Previously Presented) A pod according to Claim 22, wherein said electromagnetic shield member comprises wire mesh arranged on or within said walls.

26. (Previously Presented) A pod according to Claim 22, wherein said electromagnetic shield member comprises metal coatings arranged on said walls.

27. (Previously Presented) A pod according to Claim 22, wherein said electromagnetic shield member comprises electromagnetic-shield materials arranged in said walls.

28. (Currently Amended) An apparatus for manufacturing a device using a substrate, said apparatus comprising:

an electromagnetic-shielded chamber;

~~handling a transfer unit, which imports the substrate into~~ in said electromagnetic-shielded chamber, ~~from a pod attached to an outside surface of~~ for transferring the substrate between said electromagnetic shielded chamber and a pod attached to an outside surface of said electromagnetic-shielded chamber; and

a processing unit ~~which performs~~ for performing a process using the substrate ~~imported by said handling unit~~ transferred into said electromagnetic-shielded chamber from the pod by said transfer unit[[;]],

wherein said electromagnetic shielded chamber has a grounded portion ~~for contacting~~ to provide a grounded connection to the attached pod.

29. (Currently Amended) An apparatus according to claim 28, wherein said electromagnetic-shielded chamber comprises a door through which said transfer unit transfers the substrate between said electromagnetic-shielded chamber and the pod, said grounded portion is arranged around [[a]] ~~said door of said electromagnetic-shielded chamber through which said handling unit imports the substrate.~~

30. (Previously Presented) An apparatus according to Claim 28, wherein the process performed by said process unit is exposure of the substrate to a pattern.

31. (Previously Presented) An apparatus according to Claim 28, wherein a lid of the pod is arranged in front of the pod.

32. (Previously Presented) An apparatus according to Claim 28, wherein a lid of the pod is arranged in a bottom of the pod.

33. (Previously Presented) An apparatus according to Claim 28, wherein walls of the pod comprises an electromagnetic shield member.

Claims 34 through 40 (Cancelled)